

Advance Product Change Notification

202502018A: A3I20X050NR1/GNR1 Release at NXP ICN8 fab in Nijmegen

Note: This notice is NXP Company

Proprietary.

Issue Date: Mar 08, 2025

Dear Lisa Hawkins,

Here is your personalized communication about an NXP notification. $\label{eq:communication}$

For detailed information we invite you to view this notification online

Management summary

A3I20X050NR/GNR1 product with AF15 technology transfer from the legacy NXP Oak Hill fab (US) to the NXP ICN8 fab in Nijmegen, The Netherlands

Change Category

[]Wafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[]Wafer Fab Materials	[]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[X]Wafer Fab Location	[]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[]Electrical spec./Test coverage
[]Firmware	[]Other			

Notification Overview

Description

A3I20X050NR/GNR1 product with AF15 technology transfer from the legacy NXP Oak Hill fab (US) to the NXP ICN8 fab in Nijmegen, The Netherlands

Reason

NXP internal wafer technology process transfer from NXP Oak Hill Fab (US) to the NXP ICN8 Fab in Nijmegen (The Netherlands)

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment Jun 20, 2025

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

No impact to existing data sheet

Disposition of Old Products

Existing inventory will be shipped until depleted

Additional information

Self qualification: view online

Timing and Logistics

The Self Qualification Report will be ready on Jun 20, 2025.

The Final PCN is planned to be issued on: Jun 20, 2025.

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by Apr 07, 2025.